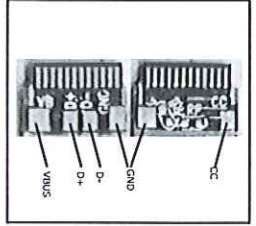


Electrical Test:

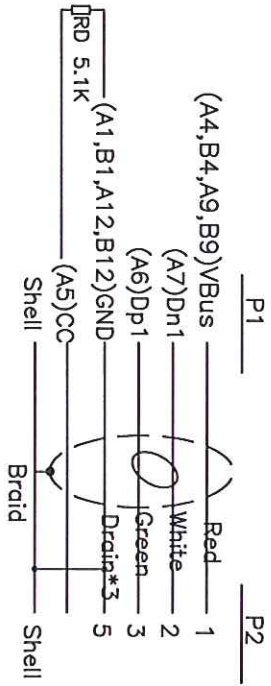
1. 100%Test(Open ,short ,miss wire)
2. Contact Resistance: 2 ohm max.
3. Insulation Resistance: 100M ohm Min.
4. Hi-Pot: 300VDC/10ms.

TYPE-C PCB pictorial view:



OK.
Allen Liu
2015.12.3

Pin Assignment



NO.	DESCRIPTION	QTY	UNIT
①	USB2.0 MICRO BM SOLDER INSULATION/BLACK SHIELD NICKEL PLATED	1	m
②	INSIDE MOLDING: PE	4	g
③	USB 2.0 C TYPE CONNECTOR BACK INSULATION NICKEL PLATED SHELL WITH PCB/INSULATION:100	16	g
④	H.S.T #1.0 BLACK	1	pcs
⑤	USB TYPE C-2in Back Nickel Plated Shell~(002.7~3.2MM)	1	pcs
⑥	Copper Foil:W=5MM 25u	1	pcs

TOLERANCE/INCH		TOLERANCE/MM	
X	±0.02"	X	±0.5mm
X.X	±0.01"	X.X	±0.20mm
X.XX	±0.008"	X.XX	±0.15mm
X.XXX	±0.005"	X.XXX	±0.10mm

TITLE: MH Mic USB2.0 Ctl Micro BM-CA,Black,3T/1m		APPD	DATE
CUSTOMER: INTRACOM Asia Co.,Ltd.		Check	15.12.02
CUSTOMER P/N: 353311		Drawer	
ICT P/N:	Unit	mm	Projection
DWG.NO:	Scale	1:1	Size: A4
THIS DRAWING MAY BE USED IN WHOLE OR PART		Sheet	1 of REV. A06